Unit: mm

TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

2SC3268

VHF~UHF Band Low Noise Amplifier Applications

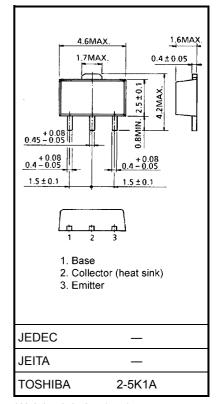
- NF = 1.7dB, $|S_{21e}|^2 = 15.0$ dB (f = 500 MHz)
- NF = 2dB, $|S_{21e}|^2 = 9.5$ dB (f = 1000 MHz)

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V _{CBO}	17	V
Collector-emitter voltage	V _{CEO}	12	V
Emitter-base voltage	V _{EBO}	3	V
Base current	Ι _Β	30	mA
Collector current	Ι _C	70	mA
Collector power dissipation	P _C	300	mW
Collector power dissipation	P _C (Note 1)	800	mW
Junction temperature	Tj	125	°C
Storage temperature range	T _{stg}	-55~150	°C

Note 1: When mounted ceramic substrate of 250 $\text{mm}^2 \times 0.8 \text{ mmt}$

Microwave Characteristics (Ta = 25°C)



Weight: 0.052 g (typ.)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Transition frequency	f _T	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 20 \text{ mA}$	_	5	_	GHz
Insertion gain	S _{21e} ² (1)	V_{CE} = 10 V, I_C = 20 mA, f = 500 MHz	_	15.0	_	dB
	S _{21e} ² (2)	V_{CE} = 10 V, I _C = 20 mA, f = 1 GHz		9.5		
Noise figure	NF (1)	V_{CE} = 10 V, I _C = 5 mA, f = 500 MHz	_	1.7	_	dB
	NF (2)	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 5 \text{ mA}, \text{ f} = 1 \text{ GHz}$	_	2.0	_	

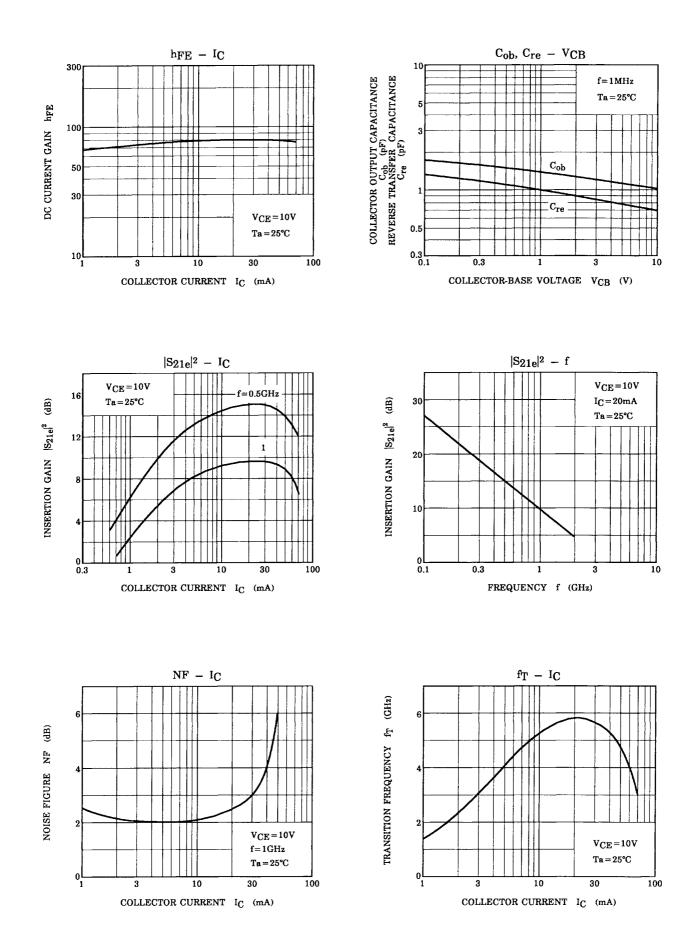
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0$	_	_	1	μ A
Emitter cut-off current	I _{EBO}	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	μA
DC current gain	h _{FE}	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 20 \text{ mA}$	25	_	_	
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0, \text{ f} = 1 \text{ MHz}$ (Note 2)	_	1.05	_	pF
Reverse transfer capacitance	C _{re}		_	0.7	_	pF

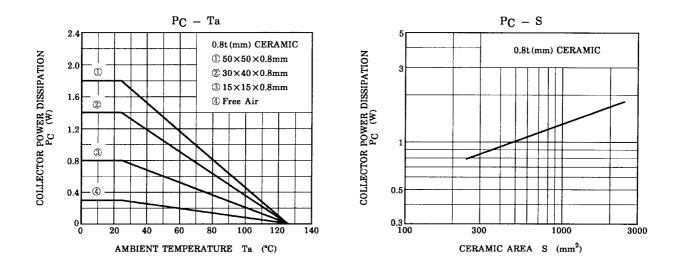
Note 2: C_{re} is measured by 3 terminal method with capacitance bridge.

Marking: ME

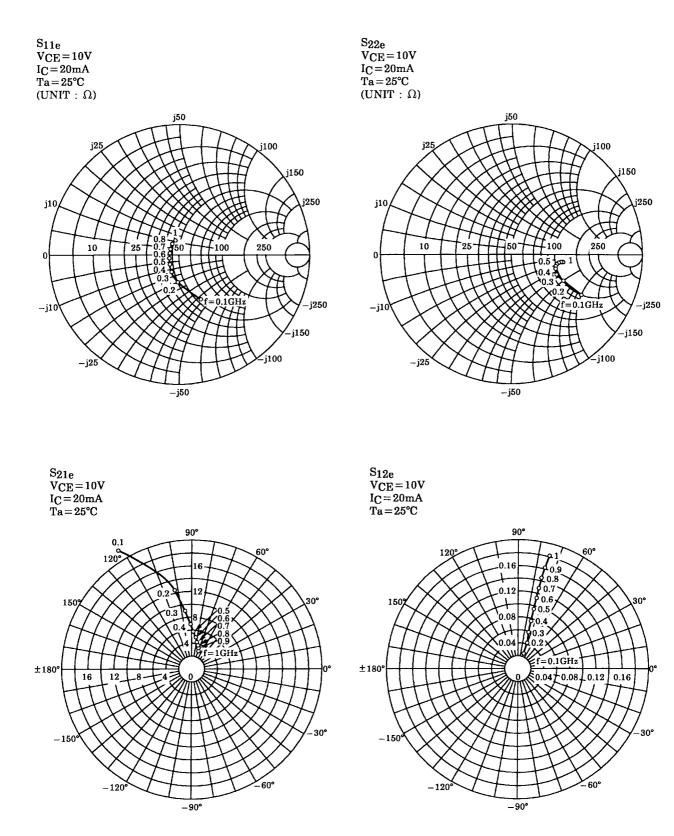
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